

# FH3415G+

## P-Channel Enhancement Mode Power MOSFET

### Description

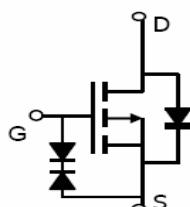
The FH3415G+ uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications. It is ESD protected.

### Application

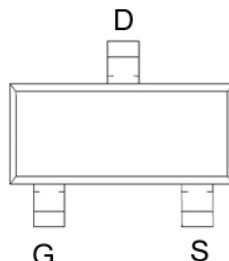
- PWM application
- Load switch

### General Features

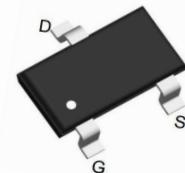
- $V_{DS} = -20V, I_D = -4.5A$
- $R_{DS(ON)} < 29m\Omega$  (Typ.) @  $V_{GS} = -4.5V$
- $R_{DS(ON)} < 41m\Omega$  (Typ.) @  $V_{GS} = -2.5V$
- High Power and current handling capability
- Lead free product is acquired
- Surface mount package
- ESD Rating : HBM Class 3A  
( 3A : ESD Voltage Range 4000~8000V )



Schematic diagram



Marking and Pin Assignment



SOT-23 top view

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 10$	V
Drain Current-Continuous	$I_D$	-4.5	A
Drain Current-Pulsed (Note 1)	$I_{DM}$	-17.6	A
Maximum Power Dissipation	$P_D$	1.25	W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	°C

### Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	100	°C/W
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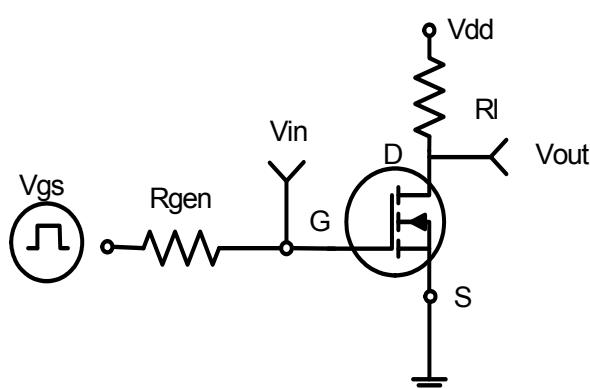
**Electrical Characteristics (TA=25 °C unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-20	-22	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±10V, V <sub>DS</sub> =0V	-	-	±10	μA
<b>On Characteristics (Note 3)</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-0.45	-0.7	-1.1	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A	-	29	39	mΩ
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-2A	-	41	54	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-4A	-	17	-	S
<b>Dynamic Characteristics (Note4)</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-10V, V <sub>GS</sub> =0V, F=1.0MHz	-	995	-	PF
Output Capacitance	C <sub>oss</sub>		-	187	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	142	-	PF
<b>Switching Characteristics (Note 4)</b>						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-10V, R <sub>L</sub> =2.5Ω V <sub>GS</sub> =-4.5V, R <sub>GEN</sub> =3Ω	-	9.5		nS
Turn-on Rise Time	t <sub>r</sub>		-	17		nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	35		nS
Turn-Off Fall Time	t <sub>f</sub>		-	20		nS
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-10V, I <sub>D</sub> =-4A, V <sub>GS</sub> =-4.5V	-	17.4		nC
Gate-Source Charge	Q <sub>gs</sub>		-	1.3	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	4.5	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>s</sub> =-1A	-	-0.78	-1	V
Diode Forward Current (Note 2)	I <sub>s</sub>		-	-	-4	A

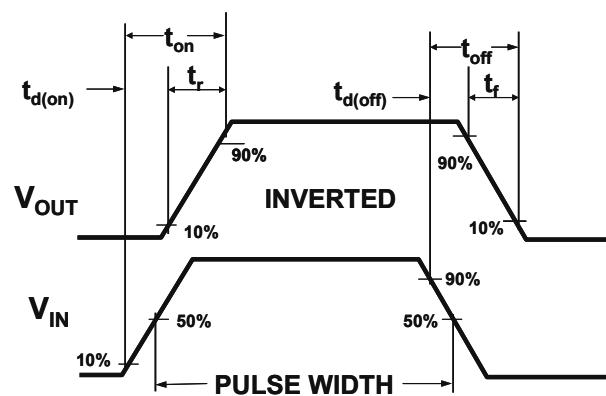
**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

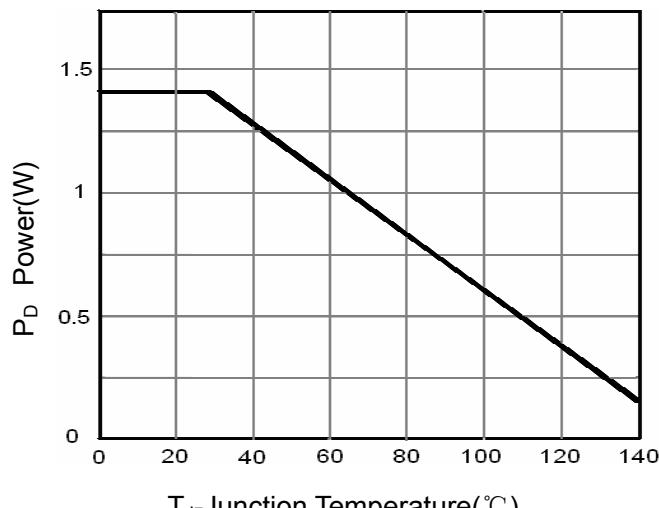
### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



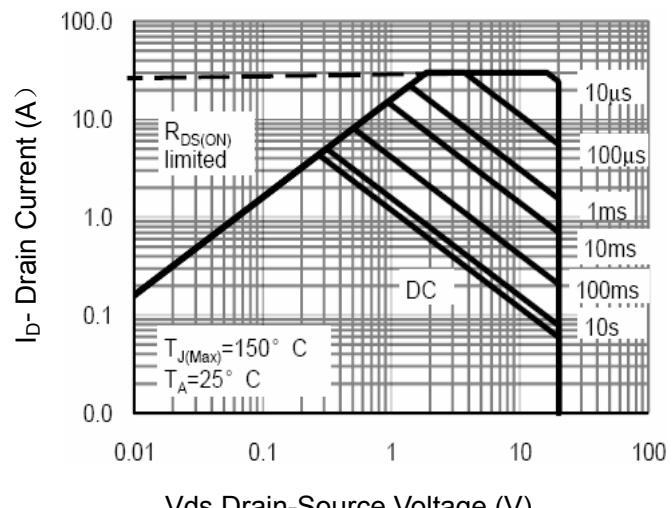
**Figure 1:Switching Test Circuit**



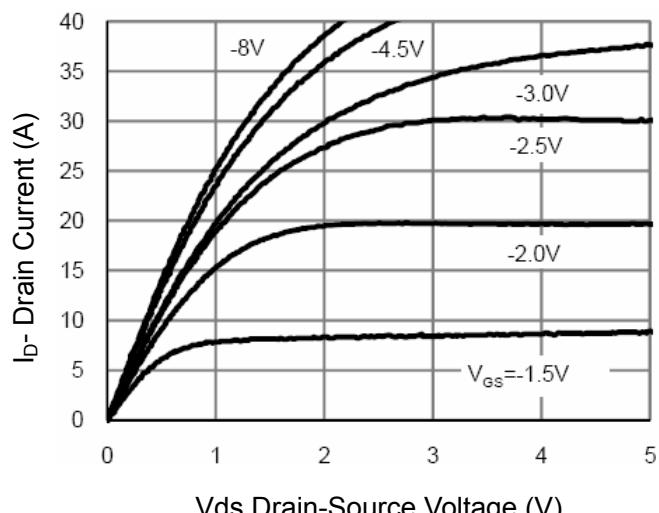
**Figure 2:Switching Waveforms**



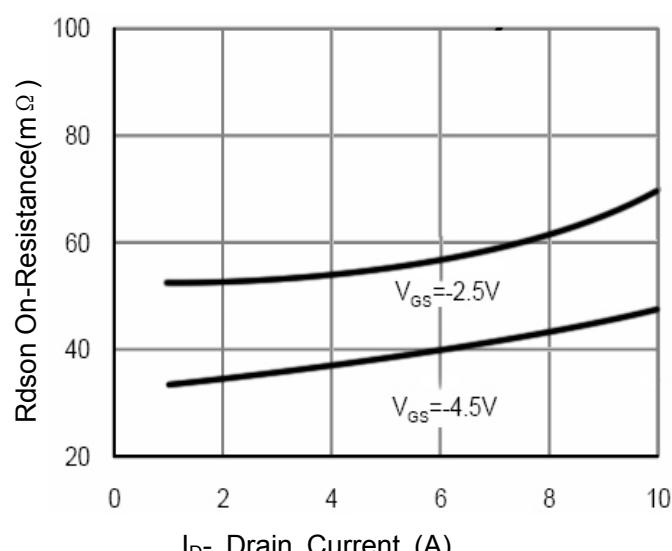
**Figure 3 Power Dissipation**



**Figure 4 Safe Operation Area**



**Figure 5 Output CHARACTERISTICS**



**Figure 6 Drain-Source On-Resistance**

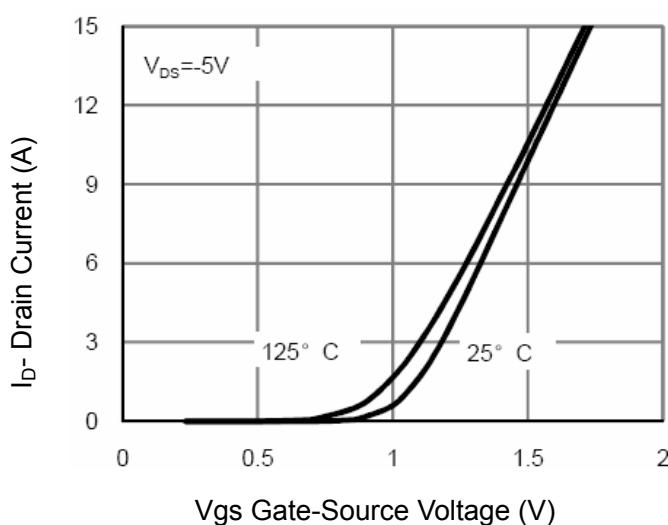


Figure 7 Transfer Characteristics

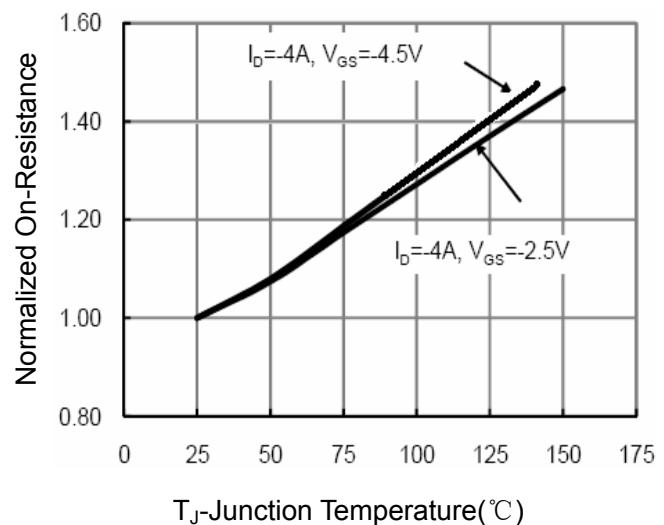


Figure 8 Drain-Source On-Resistance

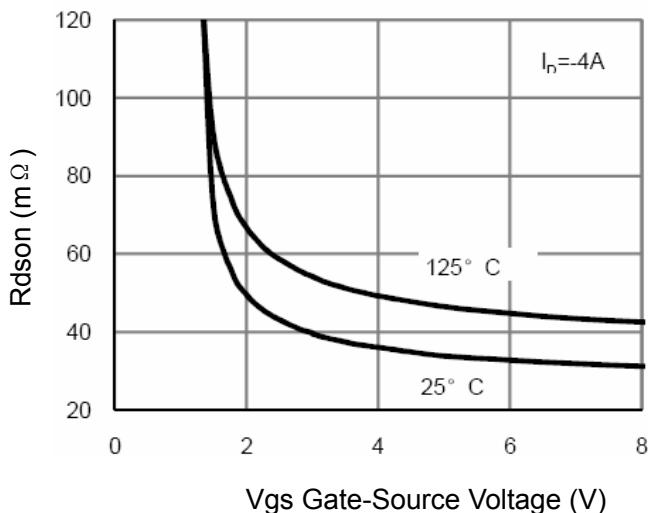


Figure 9  $R_{DS(on)}$  vs  $V_{GS}$

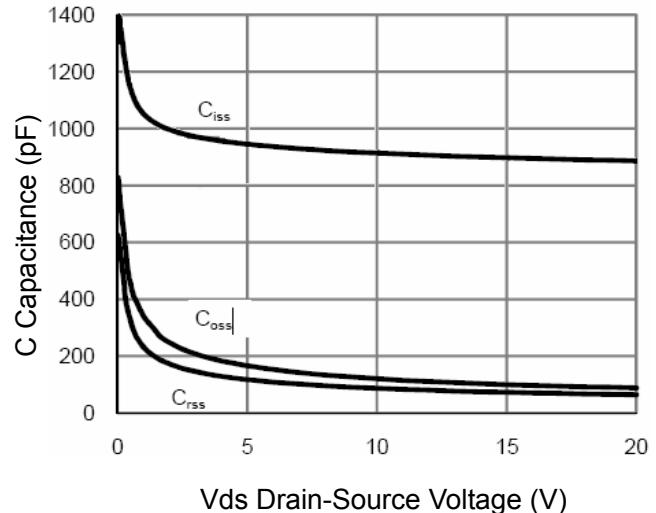


Figure 10 Capacitance vs  $V_{DS}$

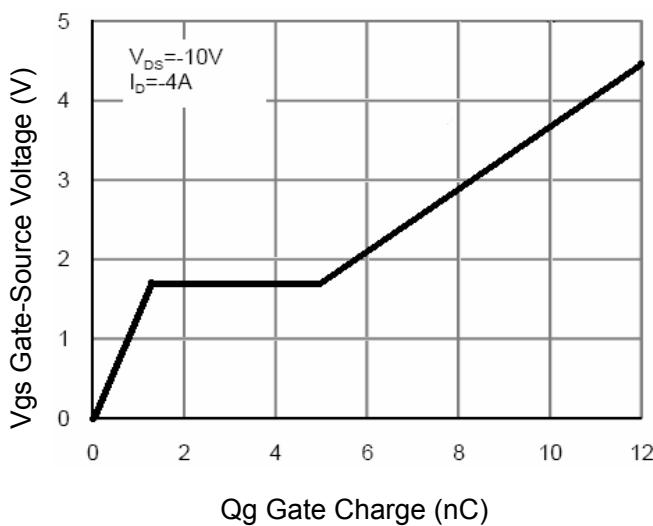


Figure 11 Gate Charge

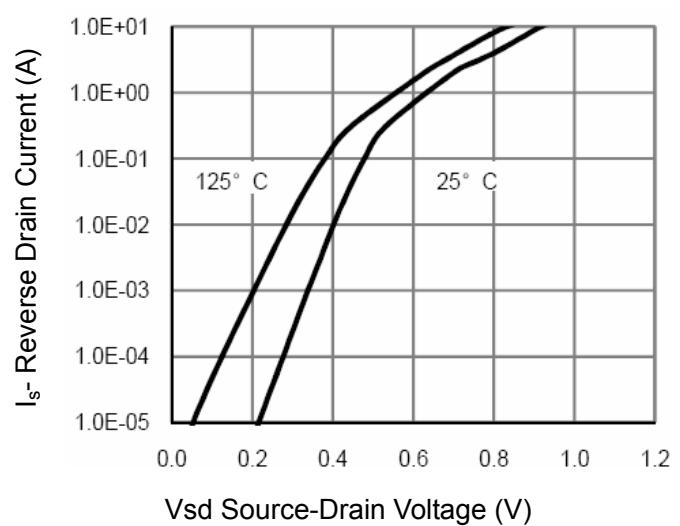
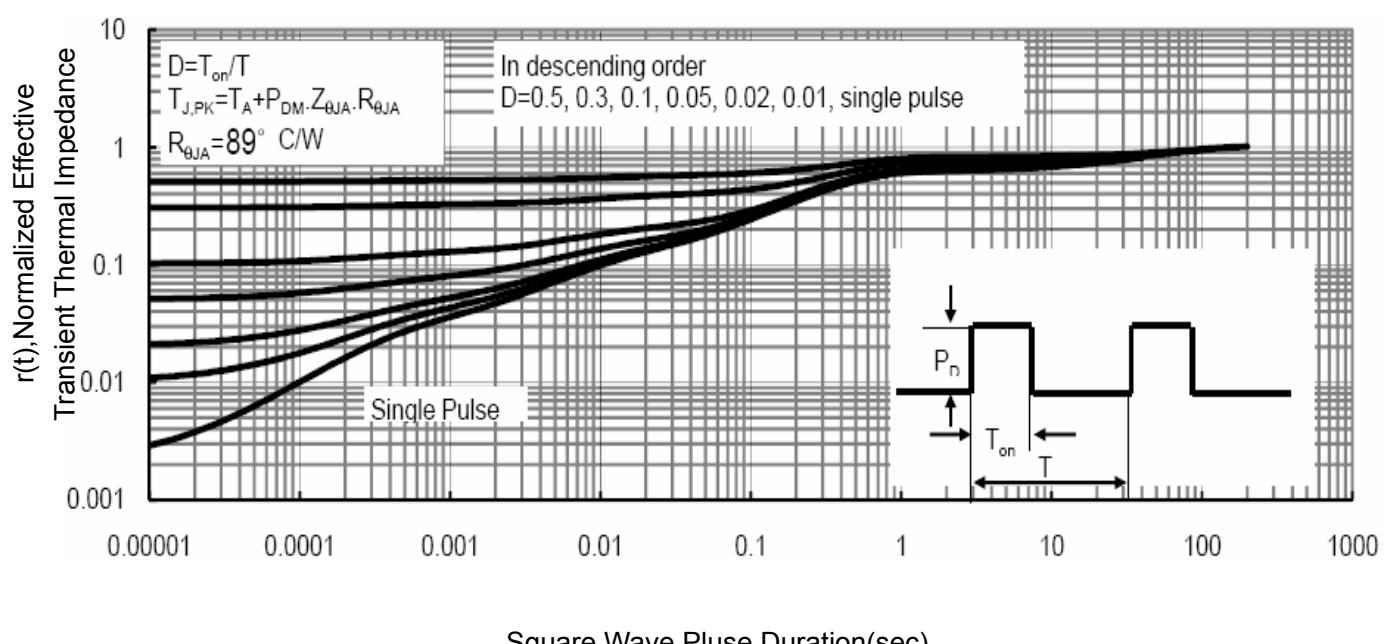
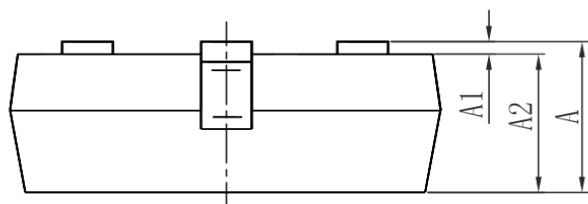
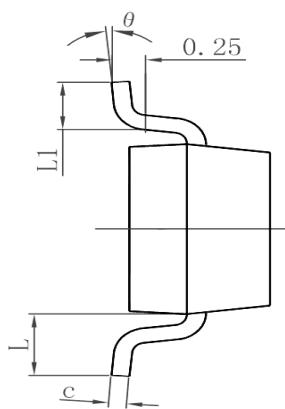
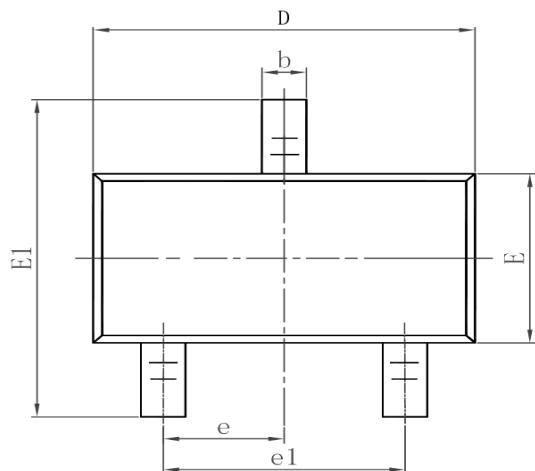


Figure 12 Source-Drain Diode Forward



**■ Package Dimensions : SOT-23**

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
$\theta$	0°	8°	0°	8°